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# Onsemi

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# Dual Precision Retriggerable/Resettable Monostable Multivibrator

The MC14538B is a dual, retriggerable, resettable monostable multivibrator. It may be triggered from either edge of an input pulse, and produces an accurate output pulse over a wide range of widths, the duration and accuracy of which are determined by the external timing components,  $C_X$  and  $R_X$ . Output Pulse Width  $T = R_X \cdot C_X$  (secs)

$$R_X = \Omega$$

$$C_X = Farads$$

# Features

- Unlimited Rise and Fall Time Allowed on the A Trigger Input
- Pulse Width Range =  $10 \ \mu s$  to  $10 \ s$
- Latched Trigger Inputs
- Separate Latched Reset Inputs
- 3.0 Vdc to 18 Vdc Operational Limits
- Triggerable from Positive (A Input) or Negative-Going Edge (B-Input)
- Capable of Driving Two Low–Power TTL Loads or One Low–Power Schottky TTL Load Over the Rated Temperature Range
- Pin–for–pin Compatible with MC14528B and CD4528B (CD4098)
- Use the MC54/74HC4538A for Pulse Widths Less Than 10  $\mu s$  with Supplies Up to 6 V
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

# MAXIMUM RATINGS (Voltages Referenced to V<sub>SS</sub>)

Symbol	Parameter	Value	Unit
V <sub>DD</sub>	DC Supply Voltage Range	-0.5 to +18.0	V
V <sub>in</sub> , V <sub>out</sub>	Input or Output Voltage Range (DC or Transient)	–0.5 to V <sub>DD</sub> + 0.5	V
I <sub>in</sub> , I <sub>out</sub>	Input or Output Current (DC or Transient) per Pin	±10	mA
PD	Power Dissipation, per Package (Note 1)	500	mW
T <sub>A</sub>	Operating Temperature Range	-55 to +125	°C
T <sub>stg</sub>	Storage Temperature Range	-65 to +150	°C
ΤL	Lead Temperature (8–Second Soldering)	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Temperature Derating: "D/DW" Packages: -7.0 mW/°C From 65°C To 125°C This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation, V<sub>in</sub> and V<sub>out</sub> should be constrained to the range V<sub>SS</sub>  $\leq$  (V<sub>in</sub> or V<sub>out</sub>)  $\leq$  V<sub>DD</sub>.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either  $V_{SS}$  or  $V_{DD}$ ). Unused outputs must be left open.



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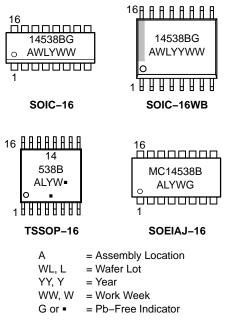
SOIC-16 D SUFFIX CASE 751B

SOIC-16WB DW SUFFIX CASE 751G



TSSOP-16 DT SUFFIX CASE 948F SOEIAJ-16 F SUFFIX CASE 966

# MARKING DIAGRAMS



(Note: Microdot may be in either location)

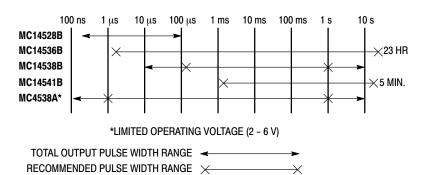
#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

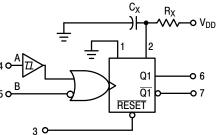
# **PIN ASSIGNMENT**

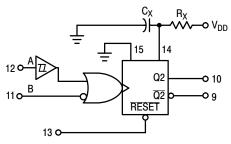
_			-
v <sub>ss</sub> [	1•	16	D V <sub>DD</sub>
C <sub>X</sub> /R <sub>X</sub> A [	2	15	] v <sub>ss</sub>
RESET A [	3	14	] C <sub>X</sub> /R <sub>X</sub> B
A <sub>A</sub> [	4	13	] RESET B
B <sub>A</sub> [	5	12	] A <sub>B</sub>
Q <sub>A</sub> [	6	11	] B <sub>B</sub>
	7	10	] Q <sub>B</sub>
V <sub>SS</sub> [	8	9	] Q <sub>B</sub>

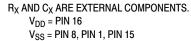
#### **ONE-SHOT SELECTION GUIDE**



BLOCK DIAGRAM







#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>	
MC14538BDG	SOIC-16 (Pb-Free)	48 Units / Rail	
NLV14538BDG*	SOIC-16 (Pb-Free)	48 Units / Rail	
MC14538BDR2G	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel	
NLV14538BDR2G*	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel	
MC14538BDTR2G	TSSOP-16 (Pb-Free)	2500 Units / Tape & Reel	
NLV14538BDTR2G*	TSSOP-16 (Pb-Free)	2500 Units / Tape & Reel	
MC14538BDWG	SOIC-16 WB (Pb-Free)	47 Units / Rail	
NLV14538BDWG*	SOIC-16 WB (Pb-Free)	47 Units / Rail	
MC14538BDWR2G	SOIC-16 WB (Pb-Free)	1000 Units / Tape & Reel	
NLV14538BDWR2G*	SOIC-16 WB (Pb-Free)	1000 Units / Tape & Reel	
MC14538BFG	SOEIAJ-16 (Pb-Free)	50 Units / Rail	
MC14538BFELG	SOEIAJ-16 (Pb-Free)	2000 Units / Tape & Reel	

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable.

#### ELECTRICAL CHARACTERISTICS (Voltages Referenced to V<sub>SS</sub>)

			V	- 5	5°C		25°C		12	5°C	
Characteristic		Symbol	V <sub>DD</sub> Vdc	Min	Max	c Min	Typ (Note 2)	Max	Min	Max	Unit
Output Voltage $V_{in} = V_{DD}$ or 0	"0" Level	V <sub>OL</sub>	5.0 10 15	- - -	0.05 0.05 0.05	- - -	0 0 0	0.05 0.05 0.05	- - -	0.05 0.05 0.05	Vdc
$V_{in} = 0 \text{ or } V_{DD}$	"1" Level	V <sub>OH</sub>	5.0 10 15	4.95 9.95 14.95	- - -	4.95 9.95 14.95	5.0 10 15	- - -	4.95 9.95 14.95	- - -	Vdc
Input Voltage $(V_O = 4.5 \text{ or } 0.5 \text{ Vdc})$ $(V_O = 9.0 \text{ or } 1.0 \text{ Vdc})$ $(V_O = 13.5 \text{ or } 1.5 \text{ Vdc})$	"0" Level	V <sub>IL</sub>	5.0 10 15	_ _ _	1.5 3.0 4.0	_ _ _	2.25 4.50 6.75	1.5 3.0 4.0		1.5 3.0 4.0	Vdc
$(V_{O} = 0.5 \text{ or } 4.5 \text{ Vdc})$ $(V_{O} = 1.0 \text{ or } 9.0 \text{ Vdc})$ $(V_{O} = 1.5 \text{ or } 13.5 \text{ Vdc})$	"1" Level	V <sub>IH</sub>	5.0 10 15	3.5 7.0 11	- - -	3.5 7.0 11	2.75 5.50 8.25	- - -	3.5 7.0 11	_ _ _	Vdc
$\begin{array}{l} \text{Output Drive Current} \\ (\text{V}_{\text{OH}} = 2.5 \ \text{Vdc}) \\ (\text{V}_{\text{OH}} = 4.6 \ \text{Vdc}) \\ (\text{V}_{\text{OH}} = 9.5 \ \text{Vdc}) \\ (\text{V}_{\text{OH}} = 13.5 \ \text{Vdc}) \end{array}$	Source	Іон	5.0 5.0 10 15	-3.0 -0.64 -1.6 -4.2	- - -	-2.4 -0.51 -1.3 -3.4	-4.2 -0.88 -2.25 -8.8	- - -	-1.7 -0.36 -0.9 -2.4	- - - -	mAdo
(V <sub>OL</sub> = 0.4 Vdc) (V <sub>OL</sub> = 0.5 Vdc) (V <sub>OL</sub> = 1.5 Vdc)	Sink	I <sub>OL</sub>	5.0 10 15	0.64 1.6 4.2		0.51 1.3 3.4	0.88 2.25 8.8	_ _ _	0.36 0.9 2.4	_ _ _	mAdo
Input Current, Pin 2 or 14		l <sub>in</sub>	15	-	±0.05	-	±0.00001	±0.05	_	±0.5	μAdc
Input Current, Other Inputs		l <sub>in</sub>	15	-	±0.1	-	±0.00001	±0.1	-	±1.0	μAdc
Input Capacitance, Pin 2 of	r 14	C <sub>in</sub>	I	-	-	-	25	-	-	-	pF
Input Capacitance, Other In (V <sub>in</sub> = 0)	nputs	C <sub>in</sub>	-	-	-	-	5.0	7.5	-	-	pF
Quiescent Current (Per Package) $Q = Low, \overline{Q} = High$		I <sub>DD</sub>	5.0 10 15	- - -	5.0 10 20	- - -	0.005 0.010 0.015	5.0 10 20	- - -	150 300 600	μAdc
Quiescent Current, Active S (Both) (Per Package) $Q = High, \overline{Q} = Low$	State	I <sub>DD</sub>	5.0 10 15	- - -	2.0 2.0 2.0	- - -	0.04 0.08 0.13	0.20 0.45 0.70	- - -	2.0 2.0 2.0	mAdo
Total Supply Current at an external load capacitance ( $C_L$ ) and at external timing network ( $R_X$ , $C_X$ ) (Note 3)		ι <sub>τ</sub>	5.0 10		$I_{\rm T} = (8.0)$ $I_{\rm T} = (1.25)$	x 10 <sup>–2</sup> ) Ř 5 x 10 <sup>–1</sup> ) ľ I <sub>T</sub> in μΑ (c C <sub>X</sub> in μF,	$C_X f + 4C_X f + C_X f + 4C_X f + 9C_X f + 9C_X f + 12C_X f + 12$	+ 2 x 10 <sup>-{</sup> Xf + 3 x 1 ble switch in k ohms	$\overline{5} C_{L}^{5} f$ $0^{-5} C_{L}^{f}$ hing only),		μAdc

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

3. The formulas given are for the typical characteristics only at 25°C.

#### **OPERATING CONDITIONS**

External Timing Resistance	R <sub>X</sub>	-	5.0	-	(Note 4)	kΩ
External Timing Capacitance	C <sub>X</sub>	-	0	-	No Limit (Note 5)	μF

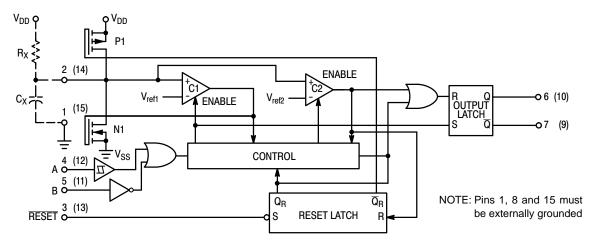
4. The maximum usable resistance R<sub>X</sub> is a function of the leakage of the capacitor C<sub>X</sub>, leakage of the MC14538B, and leakage due to board layout and surface resistance. Susceptibility to externally induced noise signals may occur for  $R_X > 1 M\Omega$ .

5. If  $C_X > 15 \,\mu\text{F}$ , use discharge protection diode per Fig. 11.

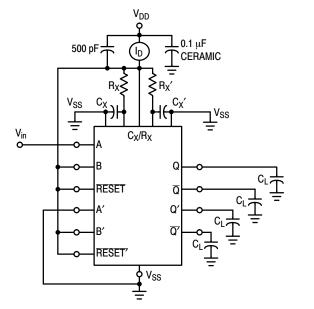
#### SWITCHING CHARACTERISTICS (Note 6) (C<sub>L</sub> = 50 pF, $T_A = 25^{\circ}C$ )

		V <sub>DD</sub>		All Types		
Characteristic	Symbol Vdc		Min	Typ (Note 7)	Max	Unit
Output Rise Time $t_{TLH} = (1.35 \text{ ns/pF}) C_L + 33 \text{ ns}$ $t_{TLH} = (0.60 \text{ ns/pF}) C_L + 20 \text{ ns}$ $t_{TLH} = (0.40 \text{ ns/pF}) C_L + 20 \text{ ns}$	t <sub>TLH</sub>	5.0 10 15		100 50 40	200 100 80	ns
Output Fall Time $t_{THL} = (1.35 \text{ ns/pF}) C_L + 33 \text{ ns}$ $t_{THL} = (0.60 \text{ ns/pF}) C_L + 20 \text{ ns}$ $t_{THL} = (0.40 \text{ ns/pF}) C_L + 20 \text{ ns}$	t <sub>THL</sub>	5.0 10 15		100 50 40	200 100 80	ns
Propagation Delay Time A or B to Q or $\overline{Q}$ $t_{PLH}$ , $t_{PHL} = (0.90 \text{ ns/pF}) C_L + 255 \text{ ns}$ $t_{PLH}$ , $t_{PHL} = (0.36 \text{ ns/pF}) C_L + 132 \text{ ns}$ $t_{PLH}$ , $t_{PHL} = (0.26 \text{ ns/pF}) C_L + 87 \text{ ns}$	t <sub>PLH</sub> , t <sub>PHL</sub>	5.0 10 15		300 150 100	600 300 220	ns
Reset to Q or $\overline{Q}$ $t_{PLH}$ , $t_{PHL} = (0.90 \text{ ns/pF}) C_L + 205 \text{ ns}$ $t_{PLH}$ , $t_{PHL} = (0.36 \text{ ns/pF}) C_L + 107 \text{ ns}$ $t_{PLH}$ , $t_{PHL} = (0.26 \text{ ns/pF}) C_L + 82 \text{ ns}$		5.0 10 15	- - -	250 125 95	500 250 190	ns
Input Rise and Fall Times Reset	t <sub>r</sub> , t <sub>f</sub>	5 10 15	- - -	_ _ _	15 5 4	μs
B Input		5 10 15		300 1.2 0.4	1.0 0.1 0.05	ms
A Input		5 10 15		No Limit		-
Input Pulse Width A, B, or Reset	t <sub>WH</sub> , t <sub>WL</sub>	5.0 10 15	170 90 80	85 45 40	_ _ _	ns
Retrigger Time	t <sub>rr</sub>	5.0 10 15	0 0 0		- - -	ns
Output Pulse Width — Q or $\overline{Q}$ Refer to Figures 8 and 9 $C_X = 0.002 \ \mu\text{F}, R_X = 100 \ \text{k}\Omega$	т	5.0 10 15	198 200 202	210 212 214	230 232 234	μs
$C_X$ = 0.1 $\mu$ F, R <sub>X</sub> = 100 k $\Omega$		5.0 10 15	9.3 9.4 9.5	9.86 10 10.14	10.5 10.6 10.7	ms
$C_X$ = 10 $\mu$ F, R <sub>X</sub> = 100 k $\Omega$		5.0 10 15	0.91 0.92 0.93	0.965 0.98 0.99	1.03 1.04 1.06	S
Pulse Width Match between circuits in the same package. $C_X = 0.1 \ \mu$ F, $R_X = 100 \ k\Omega$	100 [(T <sub>1</sub> – T <sub>2</sub> )/T <sub>1</sub> ]	5.0 10 15		±1.0 ±1.0 ±1.0	±5.0 ±5.0 ±5.0	%

6. The formulas given are for the typical characteristics only at 25°C.
7. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.







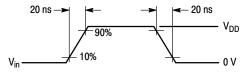


Figure 2. Power Dissipation Test Circuit and Waveforms

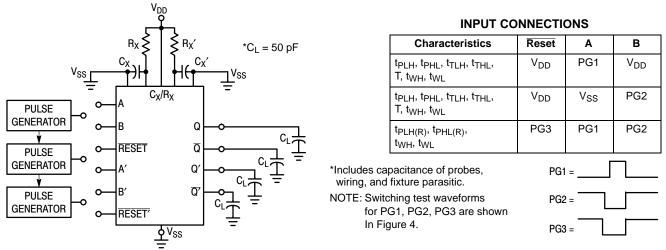


Figure 3. Switching Test Circuit

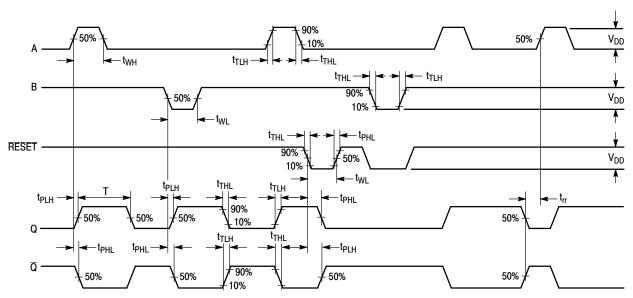
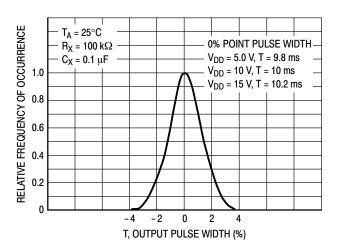


Figure 4. Switching Test Waveforms





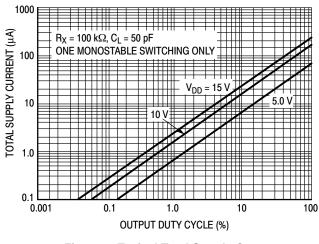


Figure 7. Typical Total Supply Current versus Output Duty Cycle

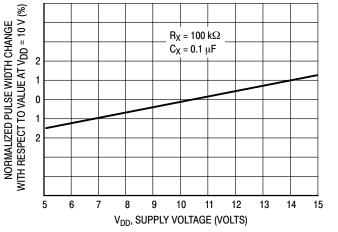
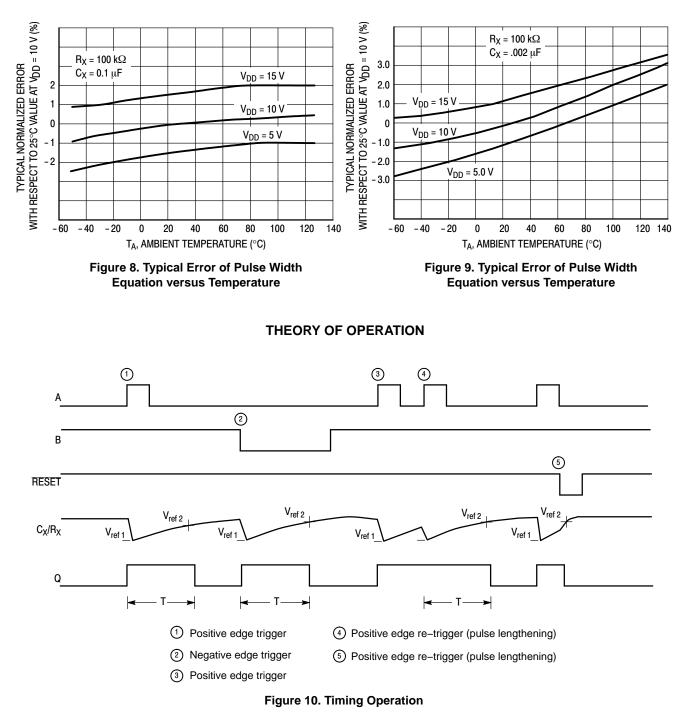


Figure 6. Typical Pulse Width Variation as a Function of Supply Voltage V<sub>DD</sub>

# FUNCTION TABLE

	Inputs	Out	puts		
Reset	Α	В	Q <u>Q</u>		
H	ے۔	H	л	U	
H	۲	∼	Л	U	
H	ノ へ	L	Not Triggered		
H	日		Not Triggered		
H	L, H, ~	Н	Not Triggered		
H	L	L, H, <i>-/</i> -	Not Triggered		
L	X	X	L	H	
てノ	X	X	Not Tr	iggered	



#### TRIGGER OPERATION

The block diagram of the MC14538B is shown in Figure 1, with circuit operation following.

As shown in Figure 1 and 10, before an input trigger occurs, the monostable is in the quiescent state with the Q output low, and the timing capacitor CX completely charged to  $V_{DD}$ . When the trigger input A goes from  $V_{SS}$  to  $V_{DD}$ (while inputs B and Reset are held to  $V_{DD}$ ) a valid trigger is recognized, which turns on comparator C1 and N-channel transistor N1 1. At the same time the output latch is set. With transistor N1 on, the capacitor CX rapidly discharges toward  $V_{SS}$  until  $V_{ref1}$  is reached. At this point the output of comparator C1 changes state and transistor N1 turns off. Comparator C1 then turns off while at the same time comparator C2 turns on. With transistor N1 off, the capacitor  $C_X$  begins to charge through the timing resistor,  $R_X$ , toward  $V_{DD}$ . When the voltage across  $C_X$  equals  $V_{ref 2}$ , comparator C2 changes state, causing the output latch to reset (Q goes low) while at the same time disabling comparator C2 2. This ends at the timing cycle with the monostable in the quiescent state, waiting for the next trigger.

In the quiescent state,  $C_X$  is fully charged to  $V_{DD}$  causing the current through resistor  $R_X$  to be zero. Both comparators are "off" with total device current due only to reverse junction leakages. An added feature of the MC14538B is that the output latch is set via the input trigger without regard to the capacitor voltage. Thus, propagation delay from trigger to Q is independent of the value of  $C_X$ ,  $R_X$ , or the duty cycle of the input waveform.

#### **RETRIGGER OPERATION**

The MC14538B is retriggered if a valid trigger occurs <sup>(3)</sup> followed by another valid trigger <sup>(4)</sup> before the Q output has returned to the quiescent (zero) state. Any retrigger, after the timing node voltage at pin 2 or 14 has begun to rise from  $V_{ref 1}$ , but has not yet reached  $V_{ref 2}$ , will cause an increase in output pulse width T. When a valid retrigger is initiated <sup>(4)</sup>, the voltage at  $C_X/R_X$  will again drop to  $V_{ref 1}$  before progressing along the RC charging curve toward  $V_{DD}$ . The Q output will remain high until time T, after the last valid retrigger.

#### **RESET OPERATION**

The MC14538B may be reset during the generation of the output pulse. In the reset mode of operation, an input pulse

on Reset sets the reset latch and causes the capacitor to be fast charged to  $V_{DD}$  by turning on transistor P1 <sup>(5)</sup>. When the voltage on the capacitor reaches  $V_{ref 2}$ , the reset latch will clear, and will then be ready to accept another pulse. It the Reset input is held low, any trigger inputs that occur will be inhibited and the Q and  $\overline{Q}$  outputs of the output latch will not change. Since the Q output is reset when an input low level is detected on the Reset input, the output pulse T can be made significantly shorter than the minimum pulse width specification.

#### **POWER-DOWN CONSIDERATIONS**

Large capacitance values can cause problems due to the large amount of energy stored. When a system containing the MC14538B is powered down, the capacitor voltage may discharge from  $V_{DD}$  through the standard protection diodes at pin 2 or 14. Current through the protection diodes should be limited to 10 mA and therefore the discharge time of the  $V_{DD}$  supply must not be faster than  $(V_{DD})$ . (C)/(10 mA). For example, if  $V_{DD} = 10$  V and  $C_X = 10 \,\mu\text{F}$ , the  $V_{DD}$  supply should discharge no faster than  $(10 \text{ V}) \times (10 \,\mu\text{F})/(10 \text{ mA}) = 10$  ms. This is normally not a problem since power supplies are heavily filtered and cannot discharge at this rate.

When a more rapid decrease of  $V_{DD}$  to zero volts occurs, the MC14538B can sustain damage. To avoid this possibility use an external clamping diode,  $D_X$ , connected as shown in Fig. 11.

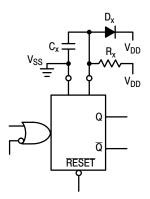
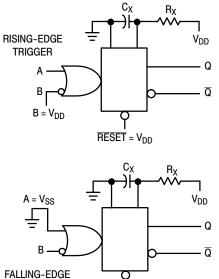
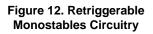


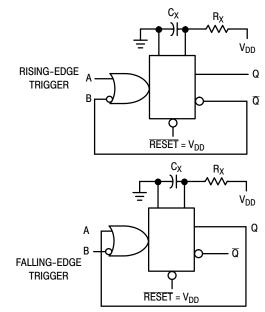
Figure 11. Use of a Diode to Limit Power Down Current Surge

#### **TYPICAL APPLICATIONS**











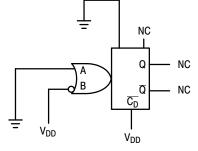
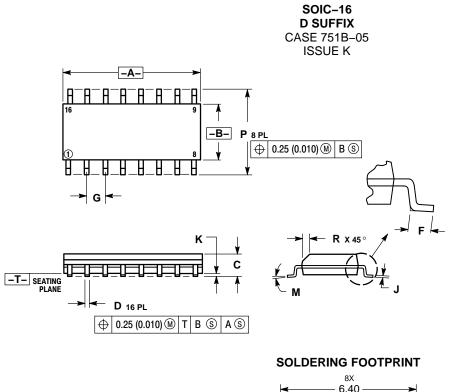
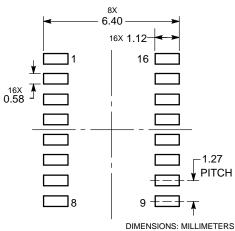


Figure 14. Connection of Unused Sections

# PACKAGE DIMENSIONS



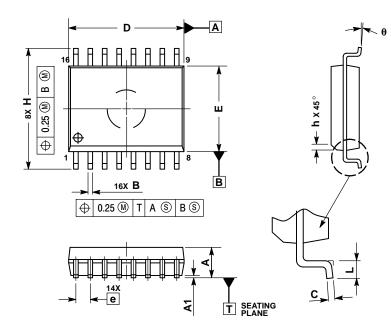


NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER. 3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE. 5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	9.80	10.00	0.386	0.393	
В	3.80	4.00	0.150	0.157	
C	1.35	1.75	0.054	0.068	
D	0.35	0.49	0.014	0.019	
F	0.40	1.25	0.016	0.049	
G	1.27	BSC	0.050 BSC		
J	0.19	0.25	0.008	0.009	
K	0.10	0.25	0.004	0.009	
М	0 °	7°	0 °	7°	
Р	5.80	6.20	0.229	0.244	
R	0.25	0.50	0.010	0.019	

#### PACKAGE DIMENSIONS

SOIC-16 WB DW SUFFIX CASE 751G-03 ISSUE D



NOTES:

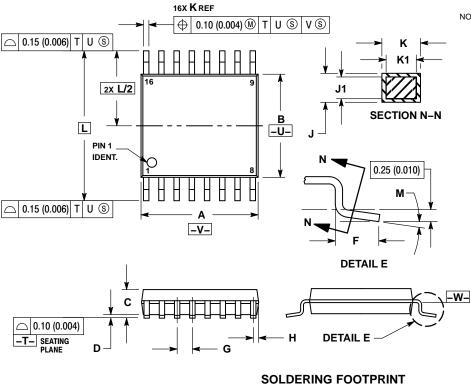
- NOTES:
   DIMENSIONS ARE IN MILLIMETERS.
   INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
   DIMENSIONS D AND E DO NOT INLCUDE MOLD PROTRUSION.
   MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
   DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION. SHALL BE 0.13 TOTAL IN EXCESS OF THE B DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS				
DIM	MIN MAX				
Α	2.35	2.65			
A1	0.10	0.25			
В	0.35	0.49			
С	0.23	0.32			
D	10.15	10.45			
Е	7.40	7.60			
е	1.27	BSC			
н	10.05	10.55			
h	0.25	0.75			
L	0.50	0.90			
q	0 °	7 °			

SOLDERING FOOTPRINT 16X 0.58 -> 11.00 1 16X 1.62 - 1.27 PITCH DIMENSIONS: MILLIMETERS

#### PACKAGE DIMENSIONS

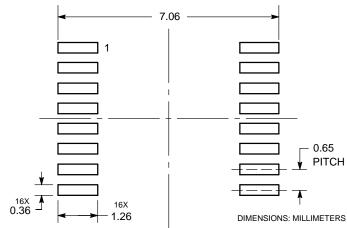




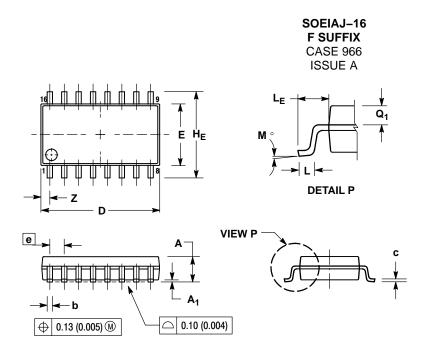
NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.06) PER SIDE.
 4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
 5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.

CONDITION. 6. TERMINAL NUMBERS ARE SHOWN FOR TERMINAL NUMBERS ARE SHOWN REFERENCE ONLY.
 DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	4.90	5.10	0.193	0.200
В	4.30	4.50	0.169	0.177
c		1.20		0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65	BSC	0.026 BSC	
Н	0.18	0.28	0.007	0.011
L	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
ĸ	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC			BSC
М	0 °	8 °	0 °	8 °



#### PACKAGE DIMENSIONS



NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER. 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0 000) DEP CIDE
- (0.006) PER SIDE. 4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- 5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α		2.05		0.081
A <sub>1</sub>	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
C	0.10	0.20	0.007	0.011
D	9.90	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
е	1.27	BSC	0.050	) BSC
HE	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
LE	1.10	1.50	0.043	0.059
М	0 °	10 °	0 °	10 °
Q <sub>1</sub>	0.70	0.90	0.028	0.035
Ζ		0.78		0.031

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